

### ACCELERATING FINITE ELEMENT METHOD WITH THE ALVEO™ U55C CARD

### INTRODUCTION

The finite element method (FEM), like all sparse matrix computation requires a great deal of data access. This requirement makes CPU memory architectures less than optimal for sparse matrix solving.

CPU caches are small and matrix queries often lack enough relevant results to maintain throughput. This results in wasted clock cycles accessing data from system memory, and causes under-utilization of CPU cores leading to performance degradation.

Xilinx Alveo U55C accelerator cards allow developers to design data pipelines where every data manipulation necessary to maintain momentum when moving from one function or block to another is accounted for, and data movement is limited. Data can flow without constant reads and writes to onboard memory. This functionally results in more work per clock cycle in an Alveo pipeline in contrast to smaller jobs across many cores in CPU (and GPU) architectures.

## **CPU Inefficiencies for Sparse Matrix**

- x86 architectures aren't equipped to provide the high I/O and bandwidth required
- CPU memory hierarchies are inflexible and create unnecessary overhead
- x86 architectures are inherently inefficient at handling data movement



### THE ALVEO U55C CARD ADVANTAGE

Built from the ground up to deliver the best performance-per-watt for HPC and Big Data workloads, the <u>Alveo™ U55C</u> <u>accelerator card</u> delivers the efficiency and scalability called for by the most demanding applications. The U55C delivers:

- High-performance, low power HBM
- Lowest performance per watt
- · Fast and easy clustering

The U55C harnesses the power of Xilinx Adaptive Computing to deliver extraordinary performance unmatched by competing architectures, with:

- Data pipeline hyperparallelism
- Superior memory management
- Optimized data movement





# **U55C HYPERPARALLEL DATA PIPELINING FOR LS-DYNA**

**LS-DYNA from ANSYS** is a general-purpose finite element program capable of simulating complex real-world problems. LS-DYNA allows designers and engineers the ability to create simulations with an infinite amount of complexity.

LS-DYNA solvers underpinning simulation represent 90% of LS-DYNA run times. Ansys tapped into Xilinx's scale-out fabric and non-hierarchical memory structure to partition workloads across multiple Alveo U55C cards to achieve **5x better performance vs. CPU**.



LS-DYNA Workload Partitioned Across Multiple Alveo U55C Cards in a Large Scale Simulation Test

- > Data is pipelined to simply stream between functions
- > Data is prepared in transit to achieve maximum throughput
- > Highly composable memory hierarchies
  - > HBM2 memory, 32 HBM channels @ 460GB/s

# TAKE THE NEXT STEP

Learn more about the Alveo U55C data center accelerator card > www.xilinx.com/AlveoU55C

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